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Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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RECEIVER NR4510UR

$\phi 50 \mu\text{m}$ InGaAs APD RECEIVER FOR 2.5 Gb/s ROSA WITH INTERNAL PRE-AMPLIFIER

DESCRIPTION

The NR4510UR is a InGaAs APD ROSA with an internal pre-amplifier in a receptacle type package designed for SFF/SFP transceiver with LC duplex receptacle. This device is ideal as a receiver for Synchronous Digital Hierarchy (SDH) system, STM-16, ITU-T recommendations.

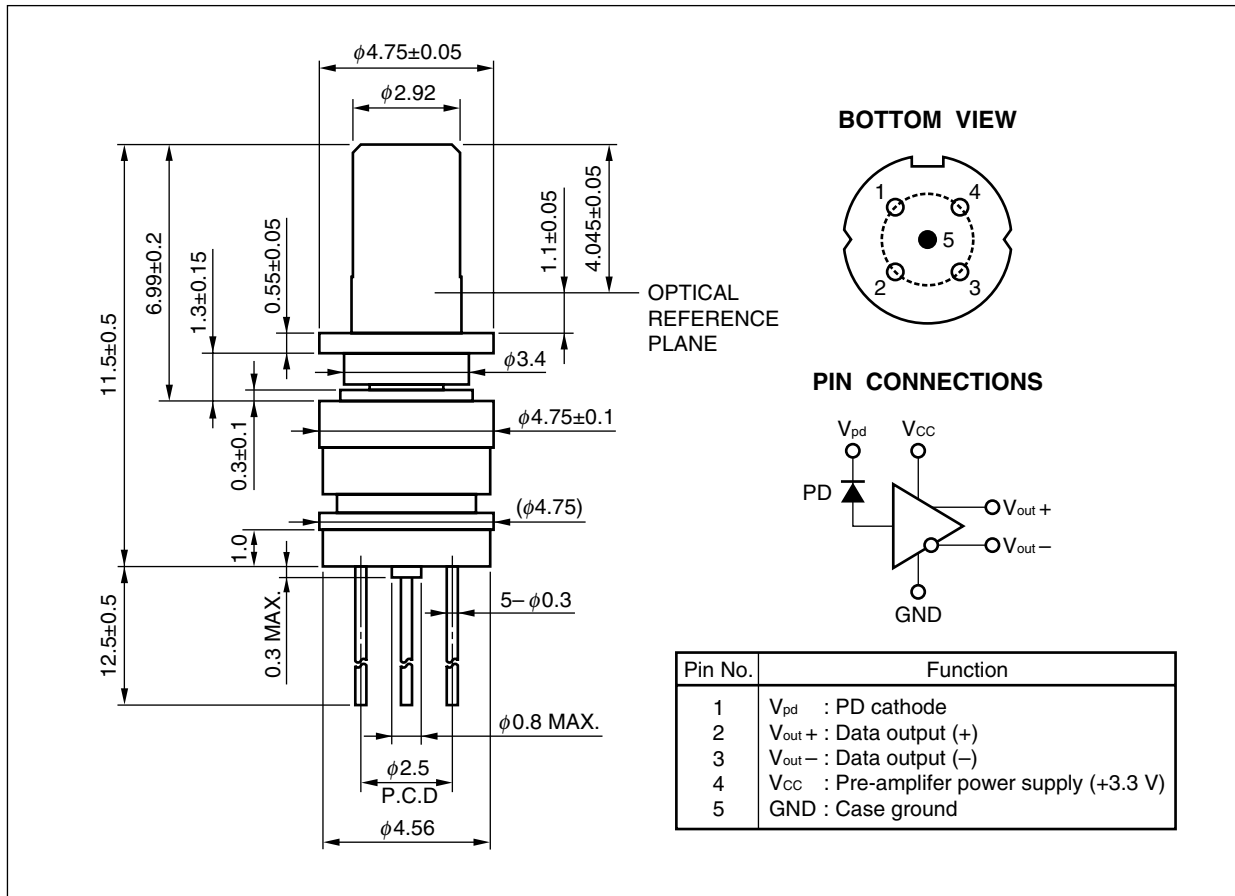
FEATURES

- Internal pre-amplifier
- Minimum receiver sensitivity $\bar{P}_r = -33 \text{ dBm}$
- Wide operating temperature range $T_c = -40 \text{ to } +85^\circ\text{C}$
- 50Ω differential output
- Small package $\phi 4.6 \text{ mm ROSA (Total length 12.0 mm MAX.)}$
- Based on Telcordia reliability



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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

PACKAGE DIMENSIONS (UNIT: mm)



ORDERING INFORMATION

Part Number	Package
NR4510UR	φ4.6 mm ROSA

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	10	mA
Reverse Current	I _R	1.5	mA
Supply Voltage	V _{CC}	4.5	V
Operating Case Temperature	T _C	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
Lead Soldering Temperature	T _{slid}	350 (3 sec.)	°C
Relative Humidity (noncondensing)	RH	85	%

ELECTRO-OPTICAL CHARACTERISTICS

(T_C = -40 to +85°C, V_{CC} = 3.3 V, λ = 1.31 μm, 1.55 μm, unless otherwise specified)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Reverse Break Down Voltage	V _{BR}	I _D = 100 μA	40	60	70	V
Temperature Coefficient of Reverse Breakdown Voltage	δ		0.09		0.15	%/°C
Dark Current	I _D	V _R = 0.9 V _{BR} , T _C = 85°C			500	nA
Minimum Receiver Sensitivity	\bar{P}_r	2.48832 Gb/s, BER = 10 ⁻¹⁰ , PRBS = 2 ²³ -1, ER = 10 dB, λ = 1.31 μm, NRZ, AC-coupled, Mopt		-33	-30	dBm
Maximum Optical Input Power	P _{ovl}	2.48832 Gb/s, BER = 10 ⁻¹⁰ , PRBS = 2 ²³ -1, ER = 10 dB, λ = 1.31 μm, NRZ, AC-coupled, M = 3	-6	-5		dBm
Sensitivity	S	M = 1, λ = 1.31 μm	0.80			A/W
		M = 1, λ = 1.55 μm	0.88			
Cut-off Frequency	f _c	AC-coupled, R _L = 50 Ω, M = 10, -3 dB Ref to 100 MHz	1.6	1.9		GHz
Optical Return Loss	ORL	SMF	27			dB
Transimpedance	Z _t	f = 100 MHz, 50 Ω single-ended, AC-coupled 50 Ω load	1.05	1.4		kΩ
Supply Voltage	V _{CC}		3.15	3.3	3.45	V
Supply Current	I _{CC}				45	mA

InGaAs APD/PD FAMILY

Part Number	Absolute Maximum Ratings		Electro-Optical Characteristics (T _c = 25°C)						Applications	Package
	T _c (°C)	T _{stg} (°C)	Detecting Area Size (μm)	I _D	f _c	S		V _R (V)		
				(nA)	(GHz)	(A/W)	@λ (nm)			
NR3470MU-CC	0 to +75	-40 to +85	φ 40	5	7.5	1.00	1 550	5	10 Gb/s: STM-64	17-pin mini-butterfly PD with an Internal pre-amplifier
NR3510UR	-40 to +85	-40 to +85	φ 50	0.1	1.8	0.80	1 310	3.3	2.5 Gb/s: STM-16	PIN ROSA with an Internal pre-amplifier
						0.85	1 550			
NR4270MU-CC	0 to +70	-40 to +85	φ 20	1.2 μA ⁻¹	7.0	0.63 ^{*2}	1 550	0.9 V _{BR}	10 Gb/s: STM-64	17-pin mini-butterfly APD with an Internal pre-amplifier
NR4500BP-CC NR4500CP-CC	0 to +85	-40 to +85	φ 50	-	2.5	0.94	1 310	0.9 V _{BR}	2.5 Gb/s: STM-16	Coaxial APD with an Internal pre-amplifier
						0.96	1 550			
NR4510UR	-40 to +85	-40 to +85	φ 50	-	1.6	0.80	1 310	0.9 V _{BR}	2.5 Gb/s: STM-16	APD ROSA with an Internal pre-amplifier
						0.88	1 550			
NR7500 Series	-40 to +85	-40 to +85	φ 50	0.1	2.5	0.89	1 310	5	2.5 Gb/s: STM-16	Coaxial PD
						0.94	1 550			
NR7800 Series	-40 to +85	-40 to +85	φ 80	0.1	2.5	0.89	1 310	5	≤ 622 Mb/s: STM-4, STM-1	Coaxial PD
						0.94	1 550			
NR8500 Series	-40 to +85	-40 to +85	φ 50	7	1	0.94	1 310	0.9 V _{BR}	≤ 622 Mb/s: STM-4, STM-1	Coaxial APD
						0.96	1 550			
NR8501 Series	-40 to +85	-40 to +85	φ 50	7	2.5	0.94	1 310	0.9 V _{BR}	2.5 Gb/s: STM-16	Coaxial APD
						0.96	1 550			

*1 MAX.

*2 MIN.

REFERENCE

Document Name	Document No.
OPTICAL SEMICONDUCTOR DEVICES FOR FIBEROPTIC COMMUNICATIONS SELECTION GUIDE	PL10161E
Opto-Electronics Devices Pamphlet	PX10160E

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<div style="border: 1px solid black; padding: 2px; display: inline-block;">Caution</div>	<p>GaAs Products</p>	<p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.
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► For further information, please contact

NEC Compound Semiconductor Devices, Ltd. <http://www.ncsd.necel.com/>
 E-mail: salesinfo@ml.ncsd.necel.com (sales and general)
 techinfo@ml.ncsd.necel.com (technical)
 5th Sales Group, Sales Division TEL: +81-44-435-1588 FAX: +81-44-435-1579

NEC Compound Semiconductor Devices Hong Kong Limited
 E-mail: ncsd-hk@elhk.nec.com.hk (sales, technical and general)
 Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
 Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
 Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH <http://www.ee.nec.de/>
 TEL: +49-211-6503-01 FAX: +49-211-6503-487

California Eastern Laboratories, Inc. <http://www.cel.com/>
 TEL: +1-408-988-3500 FAX: +1-408-988-0279